

01/30/02  
J1064 U.S. PTO

02-05-02

02/09/10  
12990/01  
JCS  
02/09/10

NON-PROVISIONAL APPLICATION FOR U. S. PATENT UNDER 37  
CFR 1.53(b)

TRANSMITTAL FORM

Attorney Docket No. TI-32857  
Assistant Commissioner for Patents  
Washington, D. C. 20231

Sir:

Transmitted herewith for filing is the  
patent application of:

"EXPRESS MAILING" Mailing Label No. EL88189952US. Date of  
Deposit: January 30, 2002. I hereby certify that this paper is being  
deposited with the U.S. Postal Service, Express Mail Post Office to  
Addressee Service under 37 CFR 1.10 on the date shown above and is  
addressed to the Assistant Commissioner for Patents, Washington, D.C.  
20231.

*Lisa Lynch*  
Lisa Lynch

Inventor(s): Baldonado, et al.

For: METHOD AND SYSTEM OF WIRE BONDING USING INTERPOSER PADS

Enclosed are:

- 6 Sheets of informal drawings and 11 pages of Specification (including Abstract)  
X A Declaration/Power of Attorney (unsigned)  
Assignment with PTO Form 1595  
X This application claims priority of U.S. Provisional Patent Application No. 60/343,652 filed on December  
28, 2001 entitled "Method and System of Wire Bonding Using Interposer Pads," and the teachings are  
incorporated herein by reference.

FEE CALCULATION				FEE	
	NUMBER		NUMBER EXTRA	RATE	BASIC FEE \$ 740.00
Total Claims	21	-20 =	1	X \$18 =	18.00
Independent Claims	3	- 3 =	0	X \$84 =	0.00
Total Filing Fee					\$758.00

Please charge Deposit Account No. 20-0668 in the amount of the total fees set forth. The Assistant Commissioner  
is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 20-0668.

All correspondence related to this application may be addressed to Mike Skrehot, at Texas Instruments  
Incorporated, M/S 3999, P. O. BOX 655474, Dallas, TX 75265.

Date

1/30/02

*Robert C. Klinger*  
Robert C. Klinger,  
Reg. No. 34,365